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high-density source and drain regions formed at the ones of the end portions of said semiconductor layer exposed beyond said spacers, the high-density source and drain regions spaced apart from the gate electrode and the capping layer; and

source and drain electrodes which directly contact, respectively, said high density source and drain regions.

- 13. (ONCE AMENDED) The TFT of claim 12, further comprising low-density source and drain regions having a same conductivity as said high-density source and drain regions formed at regions of said semiconductor layer under said spacers between the gate electrode and the high-density source and drain regions, wherein said semiconductor layer has lightly doped drain (LDD) regions under said spacers.
- 14. (UNAMENDED) The TFT of claim 12, wherein said first insulating layer, said capping layer and said spacer are one of an oxide layer and a nitride layer.
- 15. (UNAMENDED) The TFT of claim 12, further comprising a silicide layer formed between said source electrode and said high-density source region and between said drain electrode and said high-density drain region.
- 16. (UNAMENDED) The TFT of claim 15, wherein said silicide layer is of a refractory metal.
  - 22. (UNAMENDED) An active matrix display device, comprising:
  - a substrate:
  - a semiconductor layer having end portions formed over said substrate;
- a first insulating layer formed over said semiconductor layer so as to expose one of the end portions of said semiconductor layer;
  - a gate electrode formed over said first insulating layer;
  - a capping layer formed over said gate electrode;

spacers formed over said first insulating layer and on side wall portions of said gate electrode and said capping layer;

high-density source and drain regions formed at the ones of the end portions of said semiconductor layer exposed beyond said spacers.

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source and drain electrodes which directly contact, respectively, said high density source and drain regions;

a planarization layer having an opening portion which exposes a portion of one of said source and drain electrodes; and

a pixel electrode formed on the planarization layer, the pixel electrode contacting one of the second source and drain electrodes through the opening portion.

- 23. (UNAMENDED) The active matrix display device of claim 22, further comprising low-density source and drain regions having a same conductivity as said high-density source and drain regions formed at off-set regions of said semiconductor layer under said spacers so as to have said semiconductor layer with lightly doped drain (LDD) regions under said spacers.
- 24. (UNAMENDED) The active matrix display device of claim 22, further comprising silicide layers formed between said source electrode and said high-density source region and between said drain electrode and said high-density drain region.
- 25. (UNAMENDED) The active matrix display device of claim 22, further comprising an organic electro-luminescence (EL) layer and a cathode electrode sequentially formed on a first predetermined area of said pixel electrode and on a second predetermined area of said planarization layer.